

N-channel 600 V, 0.17 Ω typ., 17 A FDmesh™ II Power MOSFET
in D²PAK, TO-220FP, TO-220 and TO-247 packages

Datasheet - production data

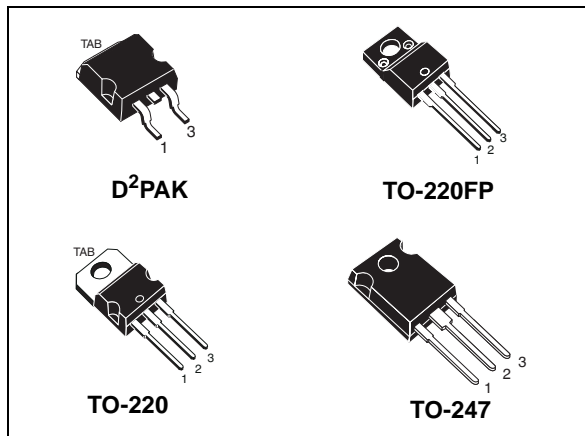
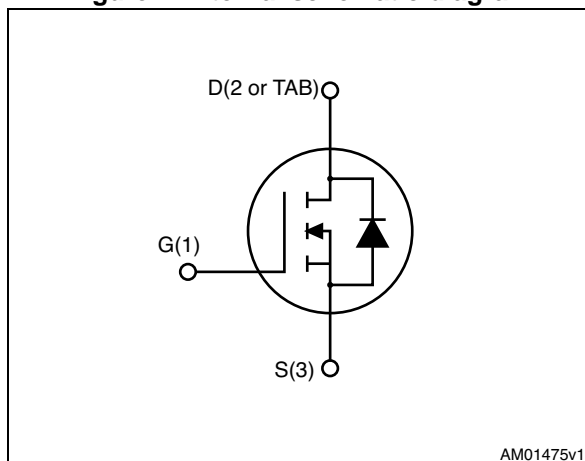


Figure 1. Internal schematic diagram



Features

| Order codes | V _{DSS} @ T _{Jmax} | R _{DS(on)} max | I _D |
|-------------|---|----------------------------|----------------|
| STB21NM60ND | 650 V | 0.22 Ω | 17 A |
| STF21NM60ND | 650 V | 0.22 Ω | 17 A |
| STP21NM60ND | 650 V | 0.22 Ω | 17 A |
| STW21NM60ND | 650 V | 0.22 Ω | 17 A |

- Intrinsic fast-recovery body diode
- Worldwide best R_{DS(on)}* area amongst the fast recovery diode devices
- 100% avalanche tested
- Low input capacitance and gate charge
- Low gate input resistance
- Extremely high dv/dt and avalanche capabilities

Applications

- Switching applications

Description

These FDmesh™ II Power MOSFETs with intrinsic fast-recovery body diode are produced using the second generation of MDmesh™ technology. Utilizing a new strip-layout vertical structure, these revolutionary devices feature extremely low on-resistance and superior switching performance. They are ideal for bridge topologies and ZVS phase-shift converters.

Table 1. Device summary

| Order codes | Marking | Package | Packaging |
|-------------|----------|--------------------|---------------|
| STB21NM60ND | 21NM60ND | D ² PAK | Tape and reel |
| STF21NM60ND | 21NM60ND | TO-220FP | Tube |
| STP21NM60ND | 21NM60ND | TO-220 | Tube |
| STW21NM60ND | 21NM60ND | TO-247 | Tube |

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1 Electrical ratings

Table 2. Absolute maximum ratings

| Symbol | Parameter | Value | | Unit |
|--------------------------------|--|--------------------------------------|-------------------|------|
| | | TO-220, D ² PAK TO-247 | TO-220FP | |
| V _{DS} | Drain-source voltage | 600 | | V |
| V _{GS} | Gate- source voltage | ±25 | | V |
| I _D | Drain current (continuous) at T _C = 25 °C | 17 | 17 ⁽¹⁾ | A |
| I _D | Drain current (continuous) at T _C = 100 °C | 10 | 10 ⁽¹⁾ | A |
| I _{DM} ⁽²⁾ | Drain current (pulsed) | 68 | 68 ⁽¹⁾ | A |
| P _{TOT} | Total dissipation at T _C = 25 °C | 140 | 30 | W |
| dv/dt ⁽³⁾ | Peak diode recovery voltage slope | 40 | | V/ns |
| V _{iso} | Insulation withstand voltage (RMS) from all three leads to external heat sink (t=1 s; T _C =25 °C) | | 2500 | V |
| T _{stg} | Storage temperature | - 55 to 150 | | °C |
| T _J | Max. operating junction temperature | 150 | | |

1. Limited by maximum junction temperature.

2. Pulse width limited by safe operating area.

3. $I_{SD} \leq 17$ A, $di/dt \leq 600$ A/ μ s, $V_{DD} = 80\% V_{(BR)DSS}$; $V_{DS(peak)} \leq V_{(BR)DSS}$

Table 3. Thermal data

| Symbol | Parameter | Value | | | | Unit |
|-----------------------|---|--------------------|----------|--------|--------|------|
| | | D ² PAK | TO-220FP | TO-220 | TO-247 | |
| R _{thj-case} | Thermal resistance junction-case max | 0.89 | 4.17 | 0.89 | | °C/W |
| R _{thj-amb} | Thermal resistance junction-ambient max | | 62.5 | | 50 | °C/W |

Table 4. Avalanche characteristics

| Symbol | Parameter | Max value | Unit |
|-----------------|--|-----------|------|
| I _{AS} | Avalanche current, repetitive or not-repetitive (pulse width limited by T _J max) | 8.5 | A |
| E _{AS} | Single pulse avalanche energy (starting T _J = 25 °C, I _D = I _{AS} , V _{DD} = 50 V) | 610 | mJ |

2 Electrical characteristics

($T_{CASE}=25^{\circ}\text{C}$ unless otherwise specified)

Table 5. On/off states

| Symbol | Parameter | Test conditions | Value | | | Unit |
|---------------|--|---|-------|-------|-----------|--------------------------------|
| | | | Min. | Typ. | Max. | |
| $V_{(BR)DSS}$ | Drain-source breakdown voltage | $I_D = 1 \text{ mA}, V_{GS} = 0$ | 600 | | | V |
| $dv/dt^{(1)}$ | Drain source voltage slope | $V_{DD} = 480 \text{ V}, I_D = 17 \text{ A}, V_{GS} = 10 \text{ V}$ | 48 | | | V/ns |
| I_{DSS} | Zero gate voltage drain current ($V_{GS} = 0$) | $V_{DS} = 600 \text{ V}$ $V_{DS} = 600 \text{ V}, T_C = 125^{\circ}\text{C}$ | | | 1 100 | μA μA |
| I_{GSS} | Gate-body leakage current ($V_{DS} = 0$) | $V_{GS} = \pm 20 \text{ V}$ | | | ± 100 | nA |
| $V_{GS(th)}$ | Gate threshold voltage | $V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$ | 3 | 4 | 5 | V |
| $R_{DS(on)}$ | Static drain-source on-resistance | $V_{GS} = 10 \text{ V}, I_D = 8.5 \text{ A}$ | | 0.170 | 0.220 | Ω |

1. Characteristic value at turn off on inductive load

Table 6. Dynamic

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|-----------------------------|-------------------------------|---|------|------|------|----------|
| C_{iss} | Input capacitance | $V_{DS} = 50 \text{ V}, f = 1 \text{ MHz}, V_{GS} = 0$ | - | 1800 | - | pF |
| C_{oss} | Output capacitance | | | 90 | | pF |
| C_{rss} | Reverse transfer capacitance | | | 8 | | pF |
| $C_{oss \text{ eq.}}^{(1)}$ | Equivalent output capacitance | $V_{GS} = 0, V_{DS} = 0 \text{ to } 480 \text{ V}$ | - | 300 | - | pF |
| $t_{d(on)}$ | Turn-on delay time | $V_{DD} = 300 \text{ V}, I_D = 8.5 \text{ A}$ $R_G = 4.7 \Omega, V_{GS} = 10 \text{ V}$ (see Figure 23), (see Figure 18) | - | 18 | - | ns |
| t_r | Rise time | | | 16 | | ns |
| $t_{d(off)}$ | Turn-off delay time | | | 70 | | ns |
| t_f | Fall time | | | 48 | | ns |
| Q_g | Total gate charge | $V_{DD} = 480 \text{ V}, I_D = 17 \text{ A}, V_{GS} = 10 \text{ V},$ (see Figure 19) | - | 60 | - | nC |
| Q_{gs} | Gate-source charge | | | 10 | | nC |
| Q_{gd} | Gate-drain charge | | | 30 | | nC |
| R_G | Gate input resistance | f=1 MHz Gate DC Bias=0 Test signal level=20 mV Open drain | - | 3 | - | Ω |

1. $C_{oss \text{ eq.}}$ is defined as a constant equivalent capacitance giving the same charging time as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS}

Table 7. Source drain diode

| Symbol | Parameter | Test conditions | Min. | Typ. | Max. | Unit |
|-----------------|-------------------------------|--|------|------|------|---------------|
| I_{SD} | Source-drain current | | | | 17 | A |
| $I_{SDM}^{(1)}$ | Source-drain current (pulsed) | | | | 68 | A |
| $V_{SD}^{(2)}$ | Forward on voltage | $I_{SD} = 17\text{ A}, V_{GS} = 0$ | | | 1.6 | V |
| t_{rr} | Reverse recovery time | $I_{SD} = 17\text{ A}, V_{DD} = 60\text{ V}$ $di/dt = 100\text{ A}/\mu\text{s}$ (see Figure 20) | | 150 | | ns |
| Q_{rr} | Reverse recovery charge | | | 0.90 | | μC |
| I_{RRM} | Reverse recovery current | | | 13 | | A |
| t_{rr} | Reverse recovery time | $I_{SD} = 17\text{ A}, V_{DD} = 60\text{ V}$ $di/dt = 100\text{ A}/\mu\text{s}$, $T_J = 150\text{ }^\circ\text{C}$ (see Figure 20) | | 210 | | ns |
| Q_{rr} | Reverse recovery charge | | | 1.6 | | μC |
| I_{RRM} | Reverse recovery current | | | 15 | | A |

1. Pulse width limited by safe operating area
2. Pulsed: Pulse duration = 300 μs , duty cycle 1.5%.

2.1 Electrical characteristics (curves)

Figure 2. Safe operating area for TO-220, D²PAK Figure 3. Thermal impedance for TO-220, D²PAK

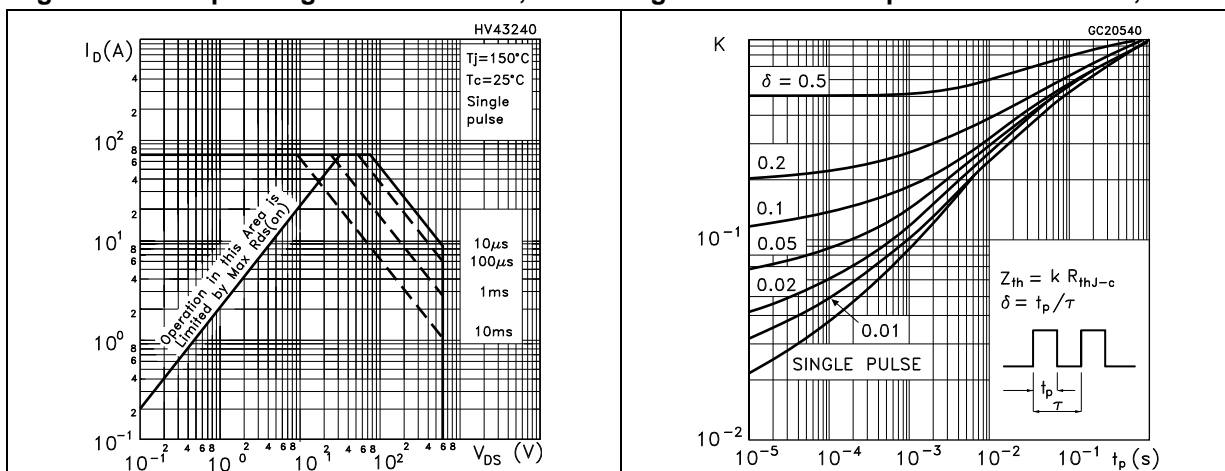


Figure 4. Safe operating area for TO-220FP

Figure 5. Thermal impedance for TO-220FP

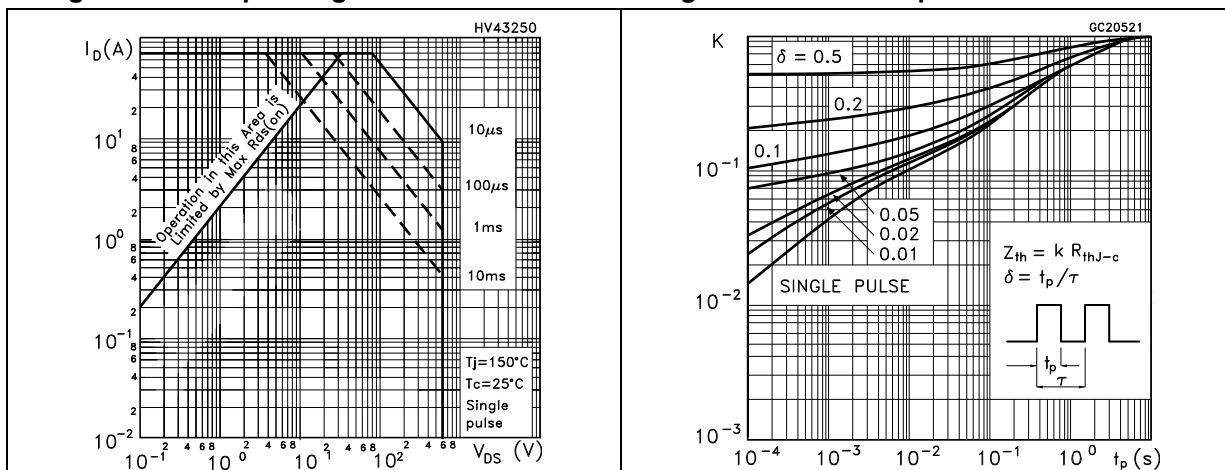


Figure 6. Safe operating area for TO-247

Figure 7. Thermal impedance for TO-247

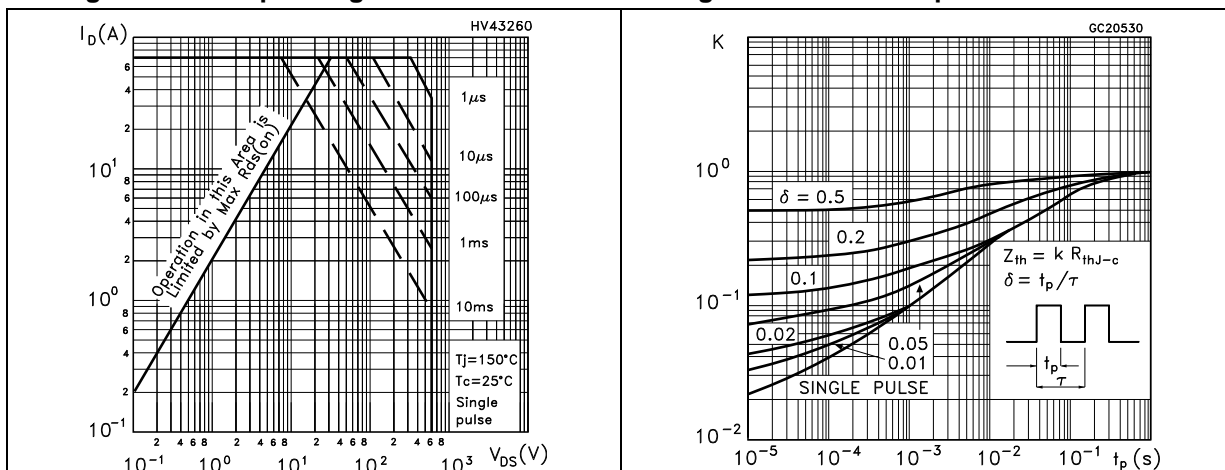


Figure 8. Output characteristics

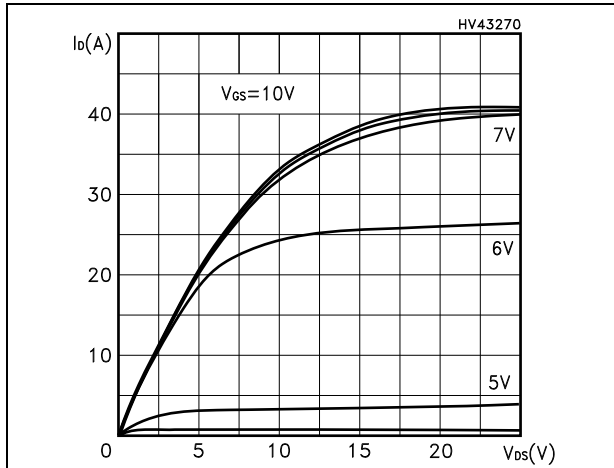


Figure 9. Transfer characteristics

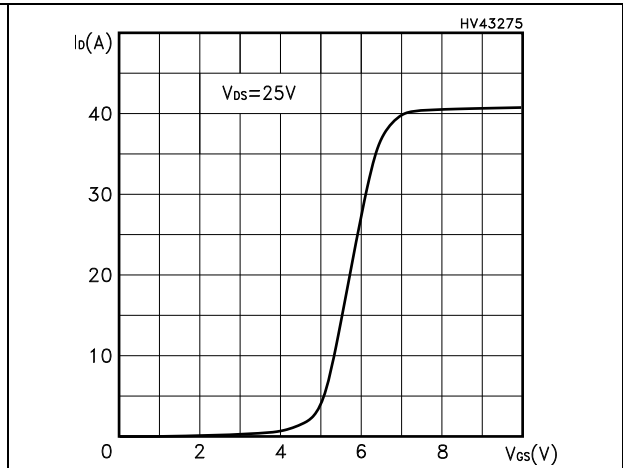


Figure 10. Transconductance

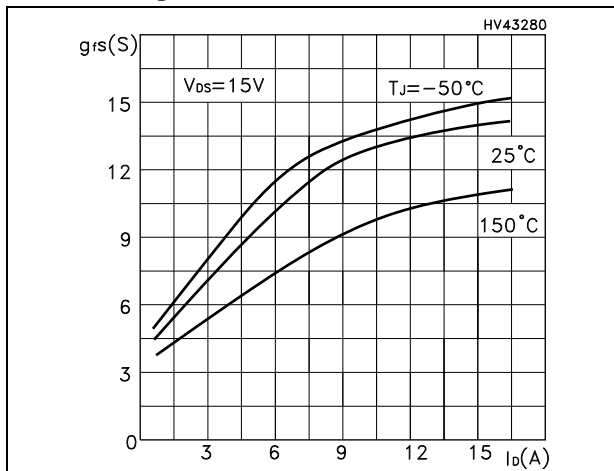


Figure 11. Static drain-source on-resistance

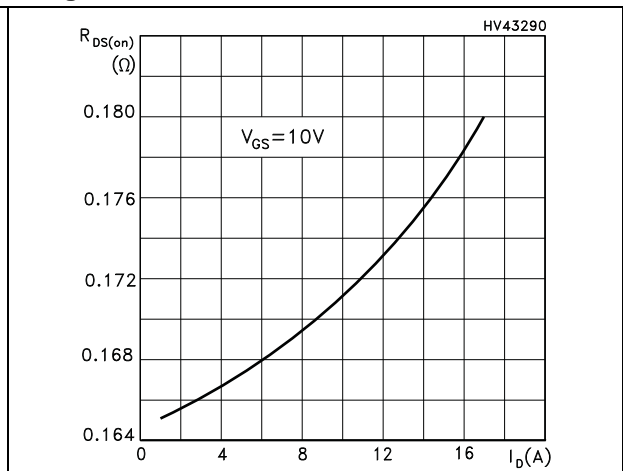


Figure 12. Gate charge vs gate-source voltage

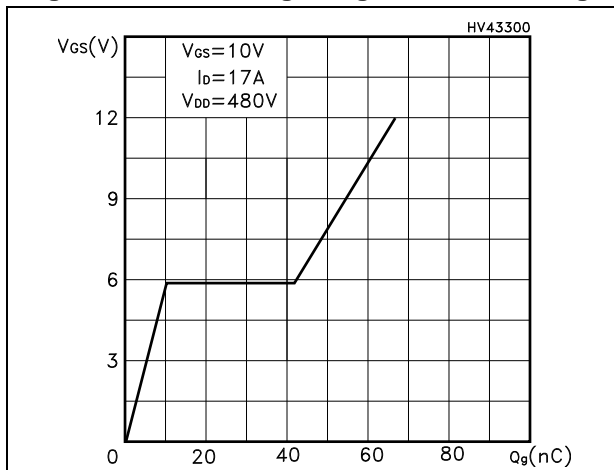


Figure 13. Capacitance variations

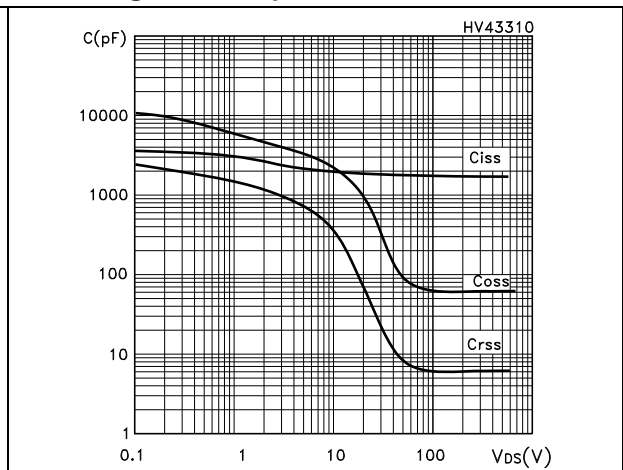


Figure 14. Normalized gate threshold voltage vs temperature

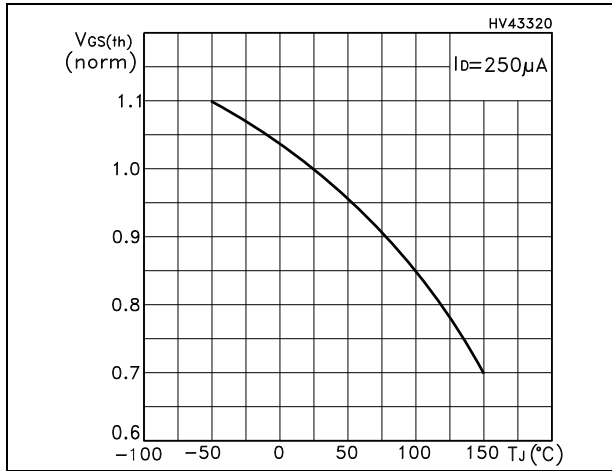


Figure 15. Normalized on-resistance vs temperature

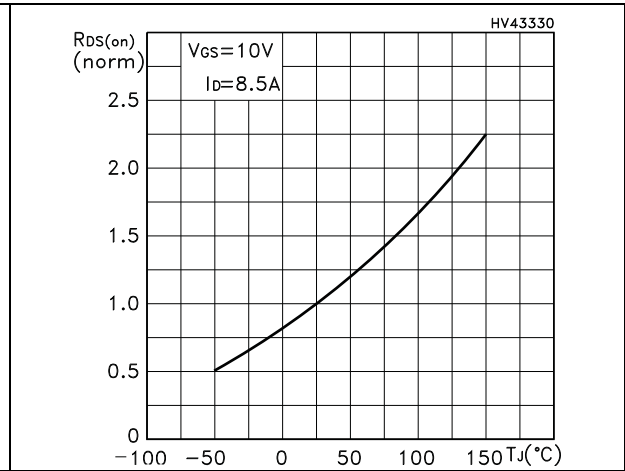


Figure 16. Source-drain diode forward characteristics

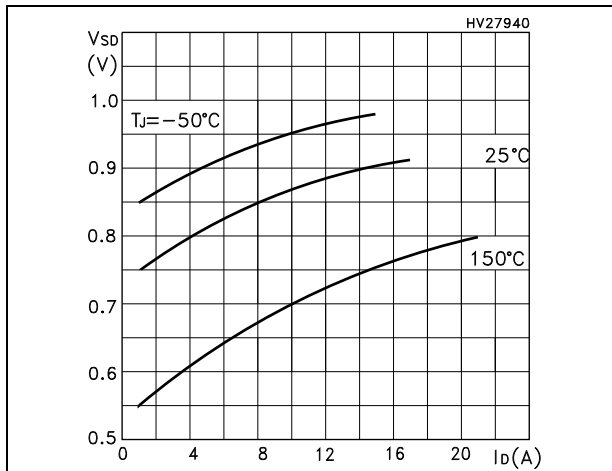
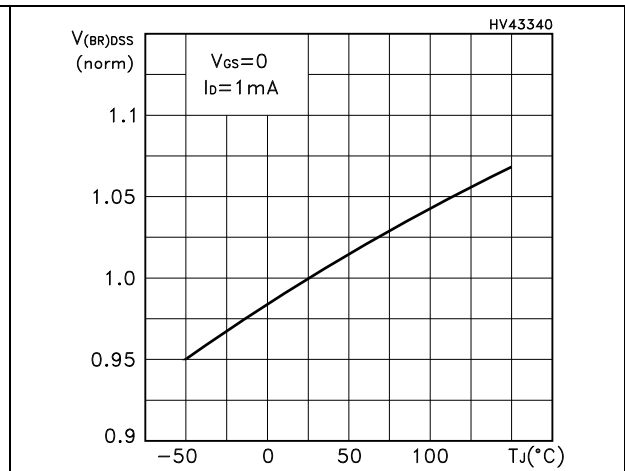


Figure 17. Normalized BV_{DSS} vs temperature



3 Test circuits

Figure 18. Switching times test circuit for resistive load



Figure 19. Gate charge test circuit



Figure 20. Test circuit for inductive load switching and diode recovery times

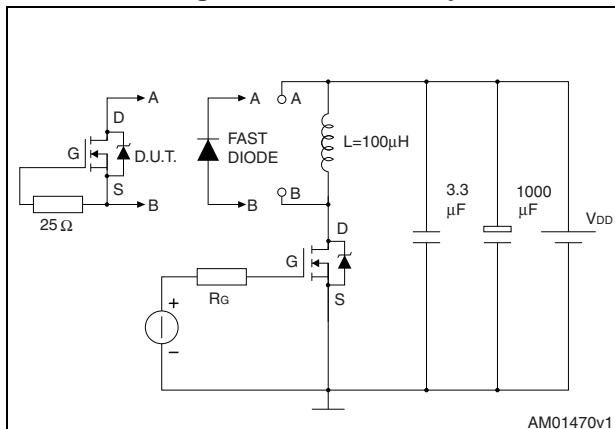


Figure 21. Unclamped inductive load test circuit



Figure 22. Unclamped inductive waveform

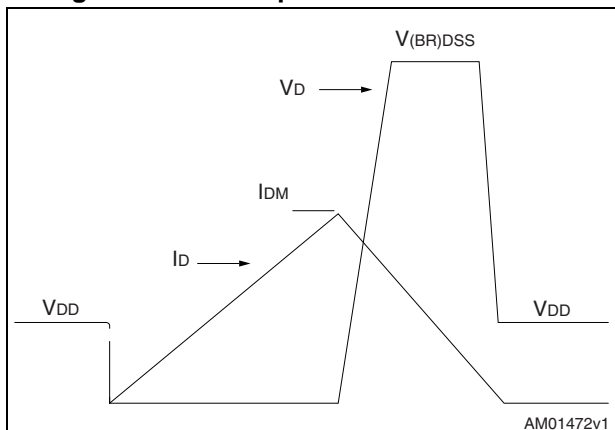
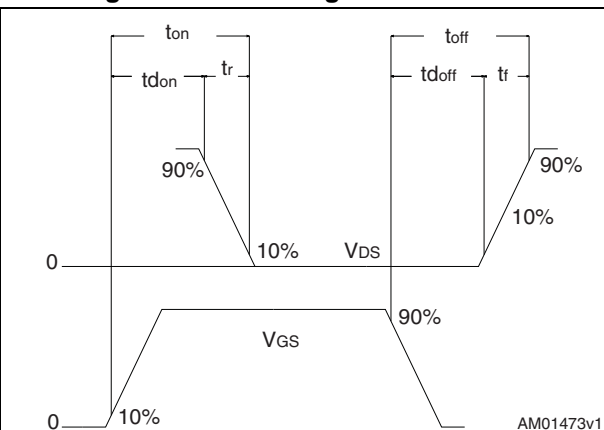


Figure 23. Switching time waveform



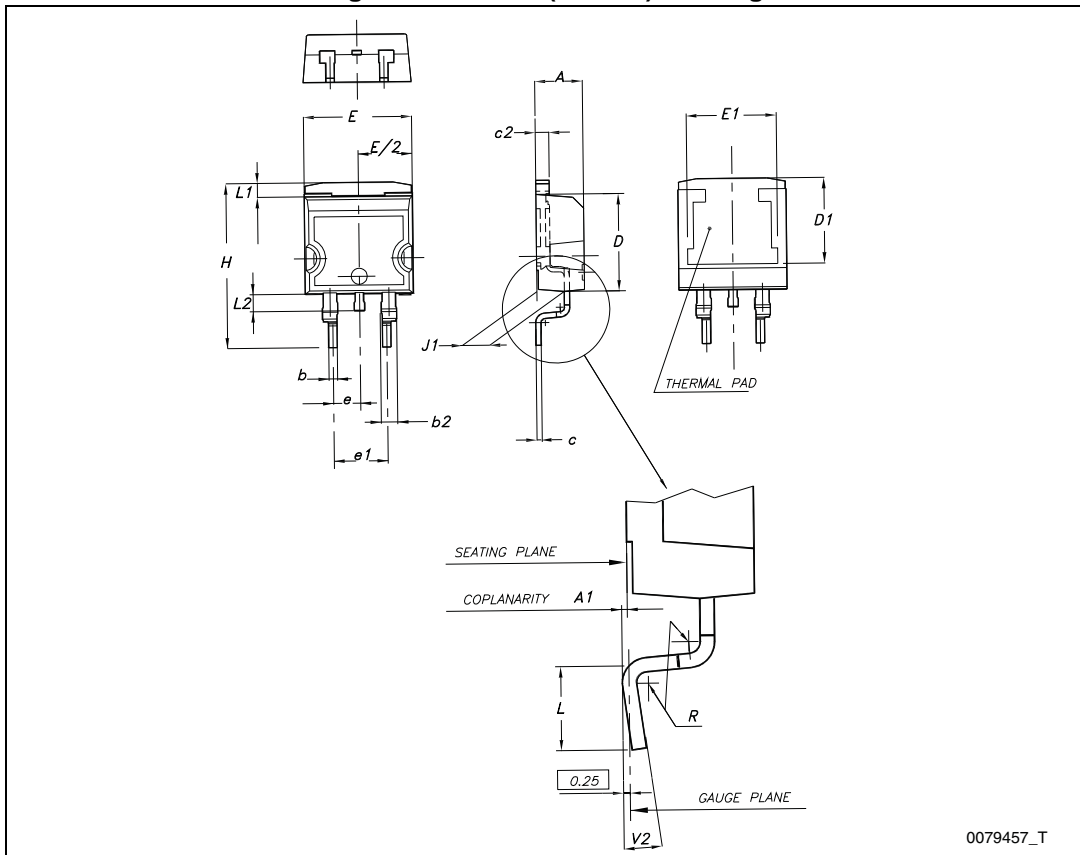
4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

Table 8. D²PAK (TO-263) mechanical data

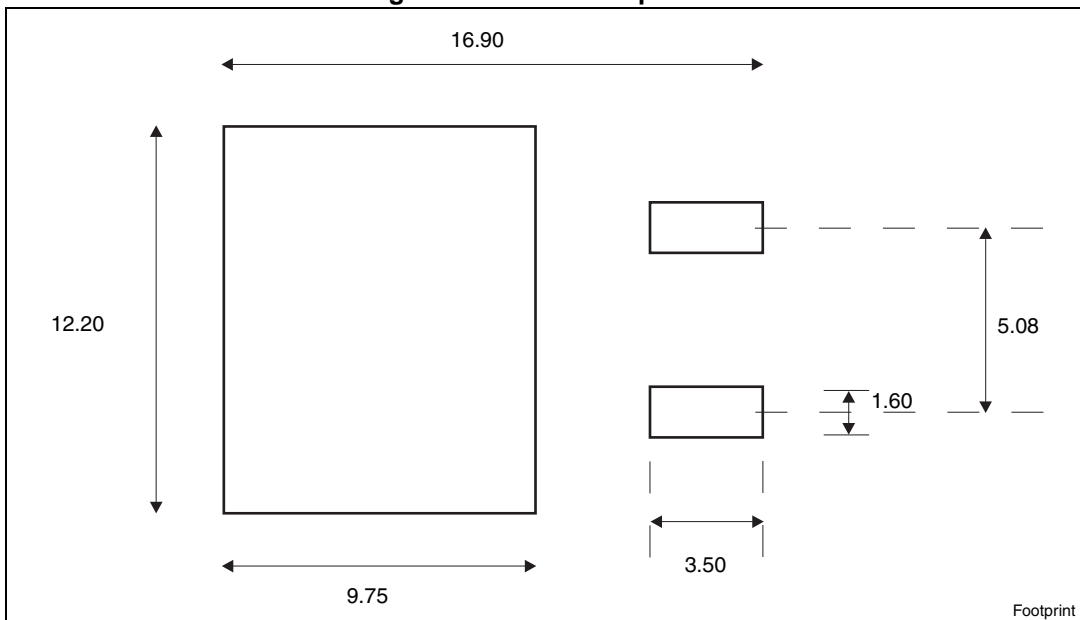
| Dim. | mm | | |
|------|------|------|-------|
| | Min. | Typ. | Max. |
| A | 4.40 | | 4.60 |
| A1 | 0.03 | | 0.23 |
| b | 0.70 | | 0.93 |
| b2 | 1.14 | | 1.70 |
| c | 0.45 | | 0.60 |
| c2 | 1.23 | | 1.36 |
| D | 8.95 | | 9.35 |
| D1 | 7.50 | | |
| E | 10 | | 10.40 |
| E1 | 8.50 | | |
| e | | 2.54 | |
| e1 | 4.88 | | 5.28 |
| H | 15 | | 15.85 |
| J1 | 2.49 | | 2.69 |
| L | 2.29 | | 2.79 |
| L1 | 1.27 | | 1.40 |
| L2 | 1.30 | | 1.75 |
| R | | 0.4 | |
| V2 | 0° | | 8° |

Figure 24. D²PAK (TO-263) drawing



0079457_T

Figure 25. D²PAK footprint^(a)



a. All dimensions are in millimeters

Table 9. TO-220FP mechanical data

| Dim. | mm | | |
|------|------|------|------|
| | Min. | Typ. | Max. |
| A | 4.4 | | 4.6 |
| B | 2.5 | | 2.7 |
| D | 2.5 | | 2.75 |
| E | 0.45 | | 0.7 |
| F | 0.75 | | 1 |
| F1 | 1.15 | | 1.70 |
| F2 | 1.15 | | 1.70 |
| G | 4.95 | | 5.2 |
| G1 | 2.4 | | 2.7 |
| H | 10 | | 10.4 |
| L2 | | 16 | |
| L3 | 28.6 | | 30.6 |
| L4 | 9.8 | | 10.6 |
| L5 | 2.9 | | 3.6 |
| L6 | 15.9 | | 16.4 |
| L7 | 9 | | 9.3 |
| Dia | 3 | | 3.2 |

Figure 26. TO-220FP drawing

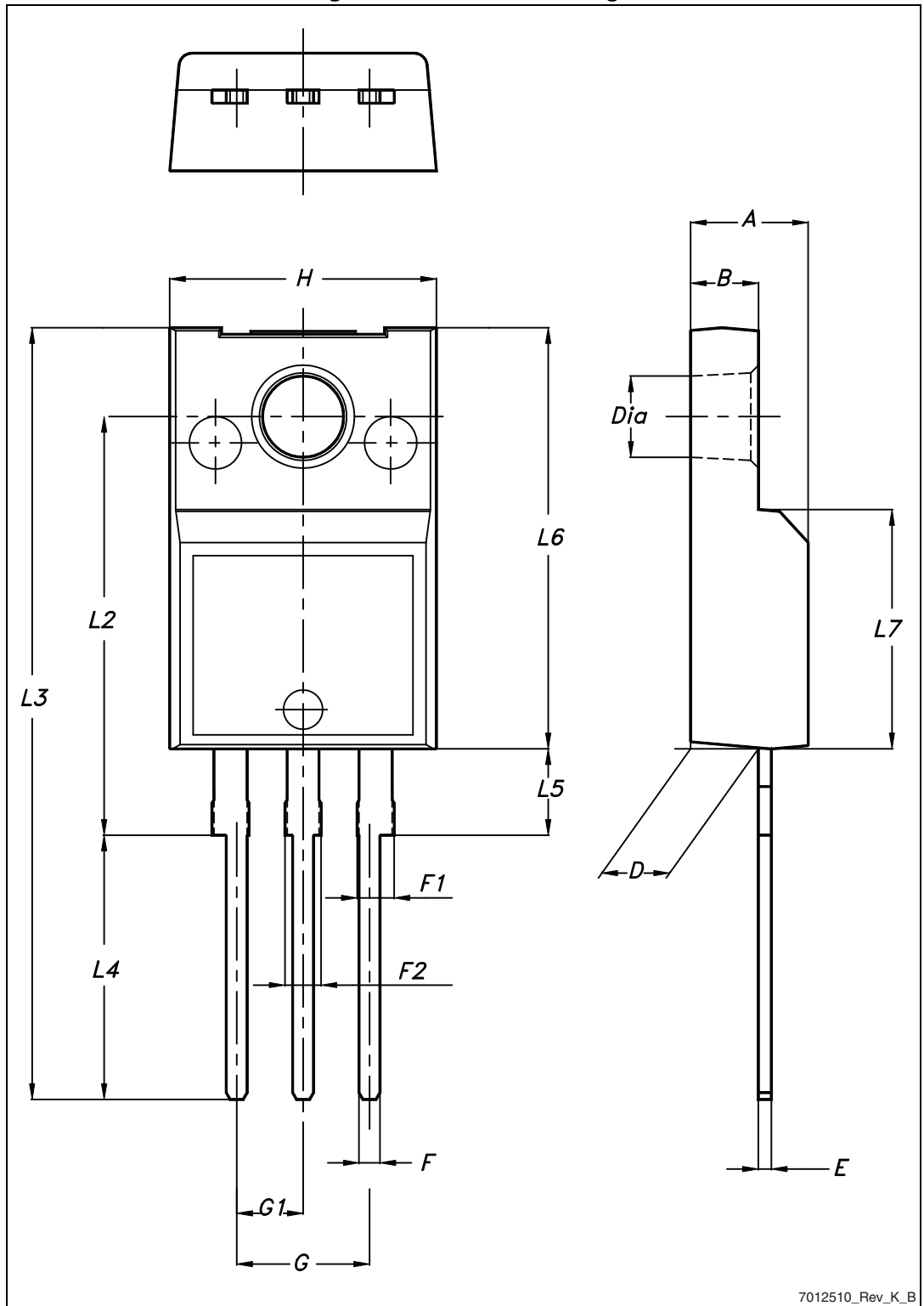


Table 10. TO-220 type A mechanical data

| Dim. | mm | | |
|------|-------|-------|-------|
| | Min. | Typ. | Max. |
| A | 4.40 | | 4.60 |
| b | 0.61 | | 0.88 |
| b1 | 1.14 | | 1.70 |
| c | 0.48 | | 0.70 |
| D | 15.25 | | 15.75 |
| D1 | | 1.27 | |
| E | 10 | | 10.40 |
| e | 2.40 | | 2.70 |
| e1 | 4.95 | | 5.15 |
| F | 1.23 | | 1.32 |
| H1 | 6.20 | | 6.60 |
| J1 | 2.40 | | 2.72 |
| L | 13 | | 14 |
| L1 | 3.50 | | 3.93 |
| L20 | | 16.40 | |
| L30 | | 28.90 | |
| ØP | 3.75 | | 3.85 |
| Q | 2.65 | | 2.95 |

Figure 27. TO-220 type A drawing

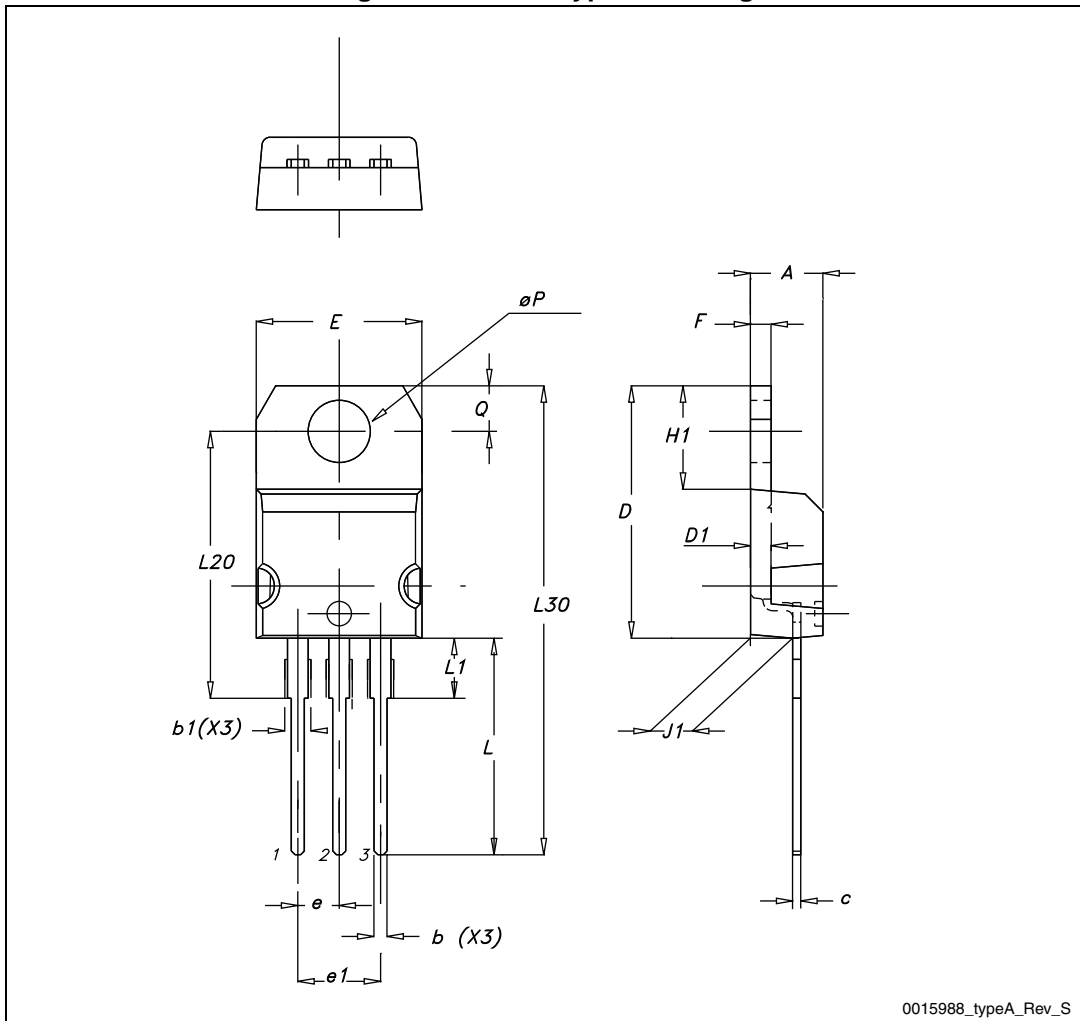
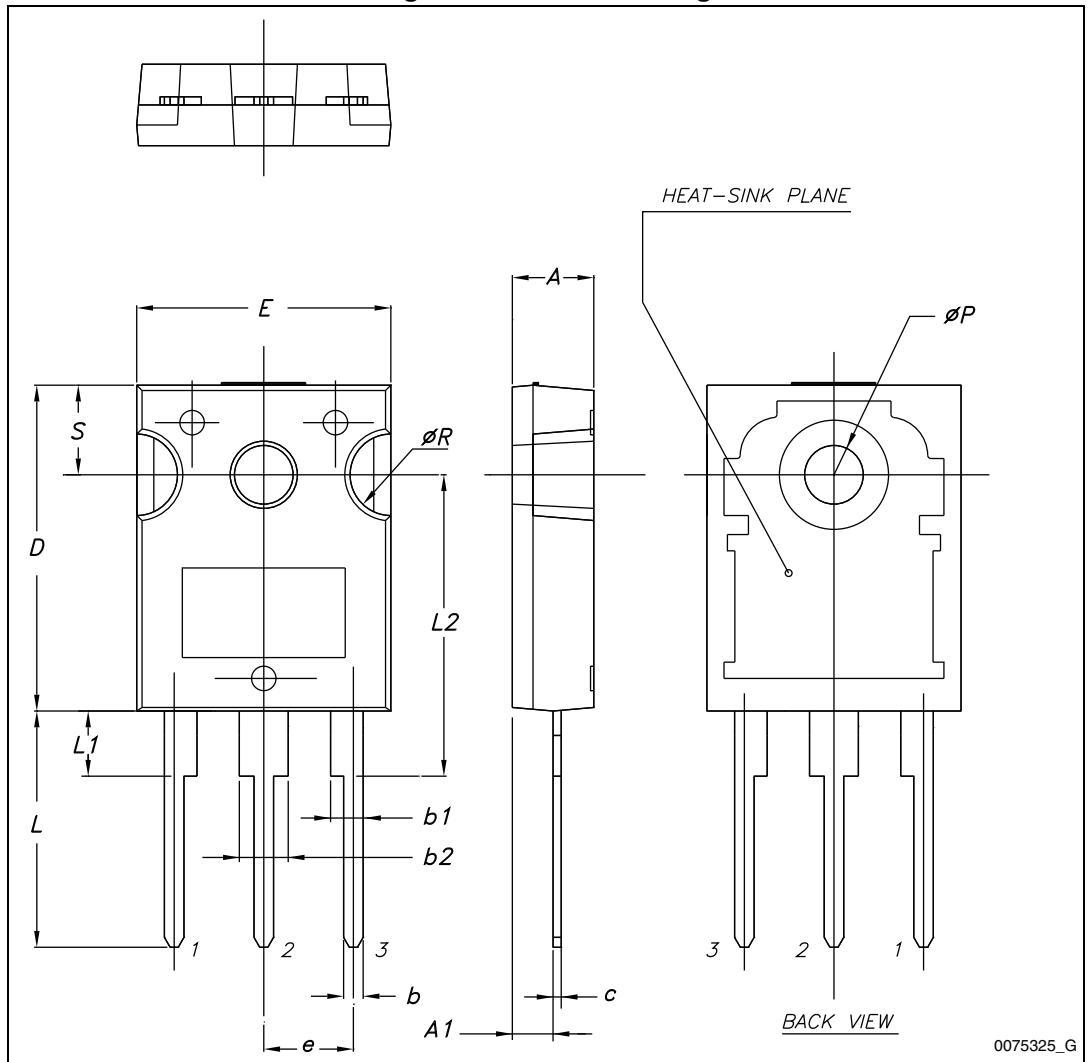


Table 11. TO-247 mechanical data

| Dim. | mm. | | |
|------|-------|-------|-------|
| | Min. | Typ. | Max. |
| A | 4.85 | | 5.15 |
| A1 | 2.20 | | 2.60 |
| b | 1.0 | | 1.40 |
| b1 | 2.0 | | 2.40 |
| b2 | 3.0 | | 3.40 |
| c | 0.40 | | 0.80 |
| D | 19.85 | | 20.15 |
| E | 15.45 | | 15.75 |
| e | 5.30 | 5.45 | 5.60 |
| L | 14.20 | | 14.80 |
| L1 | 3.70 | | 4.30 |
| L2 | | 18.50 | |
| ØP | 3.55 | | 3.65 |
| ØR | 4.50 | | 5.50 |
| S | 5.30 | 5.50 | 5.70 |

Figure 28. TO-247 drawing



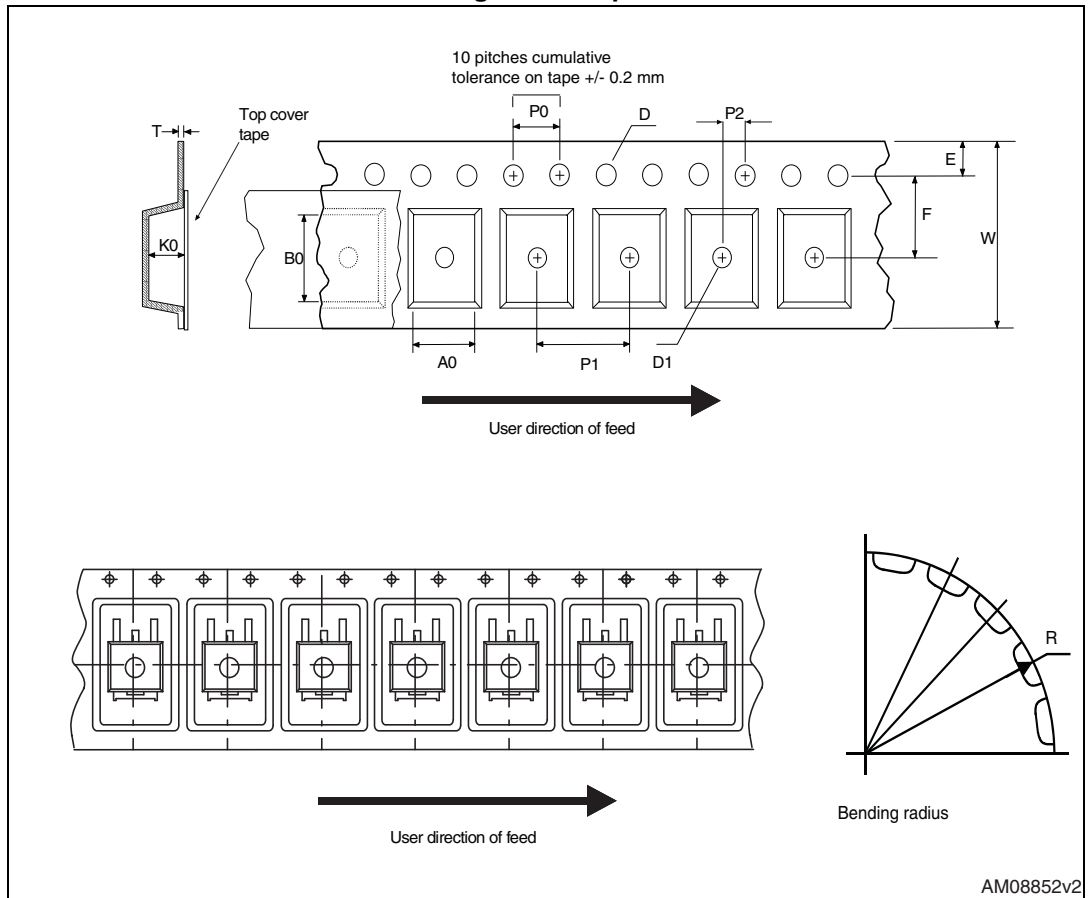
0075325_G

5 Packing mechanical data

Table 12. D²PAK (TO-263) tape and reel mechanical data

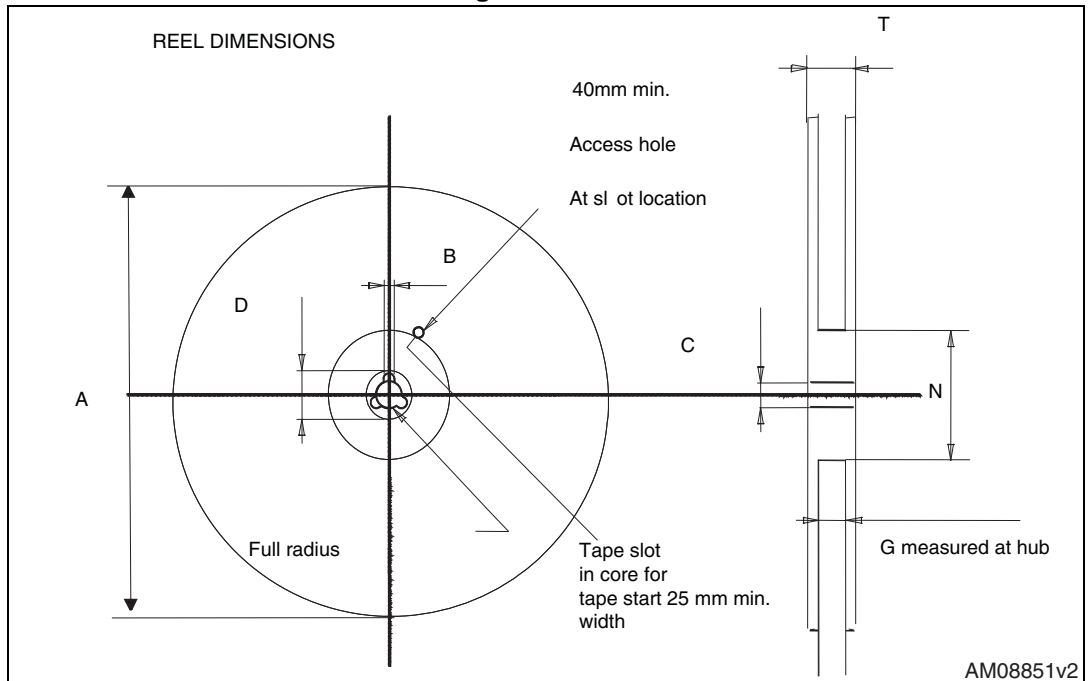
| Tape | | | Reel | | |
|------|------|------|------|----------|------|
| Dim. | mm | | Dim. | mm | |
| | Min. | Max. | | Min. | Max. |
| A0 | 10.5 | 10.7 | A | | 330 |
| B0 | 15.7 | 15.9 | B | 1.5 | |
| D | 1.5 | 1.6 | C | 12.8 | 13.2 |
| D1 | 1.59 | 1.61 | D | 20.2 | |
| E | 1.65 | 1.85 | G | 24.4 | 26.4 |
| F | 11.4 | 11.6 | N | 100 | |
| K0 | 4.8 | 5.0 | T | | 30.4 |
| P0 | 3.9 | 4.1 | | | |
| P1 | 11.9 | 12.1 | | Base qty | 1000 |
| P2 | 1.9 | 2.1 | | Bulk qty | 1000 |
| R | 50 | | | | |
| T | 0.25 | 0.35 | | | |
| W | 23.7 | 24.3 | | | |

Figure 29. Tape



AM08852v2

Figure 30. Reel



AM08851v2

6 Revision history

Table 13. Document revision history

| Date | Revision | Changes |
|-------------|----------|--|
| 05-Sep-2007 | 1 | First release. |
| 22-Apr-2008 | 2 | Datasheet status promoted from preliminary data to datasheet. |
| 27-Mar-2009 | 3 | <i>Figure 13</i> has been updated. Updated ECOPACK [®] statement (<i>Section 4: Package mechanical data</i>) |
| 16-Nov-2012 | 4 | <i>Section 4: Package mechanical data</i> has been updated Minor text changes. |
| 06-Mar-2013 | 5 | Updated dv/dt value on <i>Table 2: Absolute maximum ratings</i> . |

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